

GaAs INTEGRATED CIRCUIT

μ PG2160T5K

L, S-BAND SINGLE CONTROL SPDT SWITCH

DESCRIPTION

The μ PG2160T5K is a GaAs MMIC for L, S-band SPDT (<u>S</u>ingle <u>P</u>ole <u>D</u>ouble <u>T</u>hrow) switch which was developed for mobile phone and other L, S-band applications.

This device can operate frequency from 0.5 to 3.0 GHz, with low insertion loss and high isolation.

This device is housed in a 6-pin plastic TSSON (<u>Thin Shrink Small Out-line Non-leaded</u>) package, and is suitable for high-density surface mounting.

FEATURES

Supply voltage : VDD = 2.4 to 2.8 V (2.6 V TYP.)
 Switch control voltage : Vcont (H) = 2.4 to VDD (2.6 V TYP.)
 : Vcont (L) = -0.2 to 0.2 V (0 V TYP.)

• Low insertion loss : Lins1 = 0.30 dB TYP. @ f = 0.5 to 1.0 GHz, $V_{DD} = 2.6$ V, $V_{cont}(H) = 2.6$ V, $V_{cont}(L) = 0$ V

: Lins2 = 0.35 dB TYP. @ f = 1.0 to 2.0 GHz, V_{DD} = 2.6 V, $V_{cont (H)}$ = 2.6 V, $V_{cont (L)}$ = 0 V : Lins3 = 0.40 dB TYP. @ f = 2.0 to 2.5 GHz, V_{DD} = 2.6 V, $V_{cont (H)}$ = 2.6 V, $V_{cont (L)}$ = 0 V : Lins4 = 0.50 dB TYP. @ f = 2.5 to 3.0 GHz, V_{DD} = 2.6 V, $V_{cont (H)}$ = 2.6 V, $V_{cont (L)}$ = 0 V

High isolation
 : ISL1 = 25 dB TYP. @ f = 0.5 to 1.0 GHz, VDD = 2.6 V, Vcont (H) = 2.6 V, Vcont (L) = 0 V

 $\begin{array}{l} : ISL2 = 18 \text{ dB TYP.} @ \text{ } f = 1.0 \text{ to } 2.0 \text{ GHz}, \text{ } \text{V}_{\text{DD}} = 2.6 \text{ V}, \text{ } \text{V}_{\text{cont }(H)} = 2.6 \text{ V}, \text{ } \text{V}_{\text{cont }(L)} = 0 \text{ V} \\ : ISL3 = 17 \text{ dB TYP.} @ \text{ } f = 2.0 \text{ to } 2.5 \text{ GHz}, \text{ } \text{V}_{\text{DD}} = 2.6 \text{ V}, \text{ } \text{V}_{\text{cont }(H)} = 2.6 \text{ V}, \text{ } \text{V}_{\text{cont }(L)} = 0 \text{ V} \\ : ISL4 = 13 \text{ dB TYP.} @ \text{ } f = 2.5 \text{ to } 3.0 \text{ GHz}, \text{ } \text{V}_{\text{DD}} = 2.6 \text{ V}, \text{ } \text{V}_{\text{cont }(H)} = 2.6 \text{ V}, \text{ } \text{V}_{\text{cont }(L)} = 0 \text{ V} \\ \end{array}$

• Handling power : P_{in} (0.1 dB) = +21.0 dBm TYP. @ f = 2.0/2.5 GHz, V_{DD} = 2.6 V, V_{cont} (H) = 2.6 V, V_{cont} (L) = 0 V

High-density surface mounting: 6-pin plastic TSSON package (1.0 × 1.0 × 0.37 mm)

APPLICATIONS

· L, S-band digital cellular or cordless telephone

W-LAN, WLL and BluetoothTM etc.

ORDERING INFORMATION

Part Num	oer	Order Number	Package	Marking	Supplying Form
μPG2160T5k	K-E2	μPG2160T5K-E2-A	6-pin plastic TSSON (Pb-Free) Note	G4	 Embossed tape 8 mm wide Pin 1, 6 face the perforation side of the tape Qty 5 kpcs/reel

Note With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

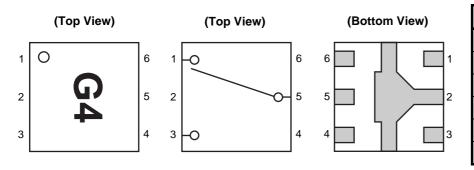
Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: μ PG2160T5K-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin Name
OUTPUT1
GND
OUTPUT2
Vcont
INPUT
V _{DD}

TRUTH TABLE

V _{cont}	INPUT-OUTPUT1	INPUT-OUTPUT2		
High	OFF	ON		
Low	ON	OFF		

ABSOLUTE MAXIMUM RATINGS (Ta = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V _{DD}	+6.0	V
Switch Control Voltage	Vcont	+6.0	V
Input Power	Pin	+26	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	T _{stg}	-55 to +135	°C

RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage Note	V _{DD}	2.4	2.6	2.8	V
Switch Control Voltage (H) Note	V _{cont (H)}	2.4	2.6	V _{DD}	V
Switch Control Voltage (L)	V _{cont} (L)	-0.2	0	0.2	V

Note $V_{cont(H)} \le V_{DD}$

ELECTRICAL CHARACTERISTICS

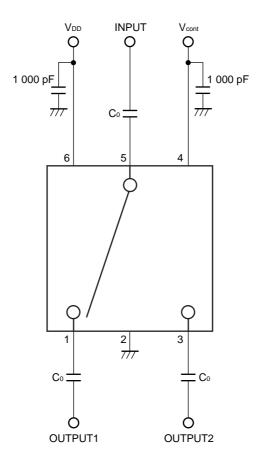
(TA = +25°C, V_{DD} = 2.6 V, V_{cont} (H) = 2.6 V, V_{cont} (L) = 0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 0.5 to 1.0 GHz	-	0.30	0.45	dB
Insertion Loss 2	Lins2	f = 1.0 to 2.0 GHz	-	0.35	0.50	
Insertion Loss 3	Lins3	f = 2.0 to 2.5 GHz	ı	0.40	0.55	
Insertion Loss 4	Lins4	f = 2.5 to 3.0 GHz	1	0.50	0.65	
Isolation 1	ISL1	f = 0.5 to 1.0 GHz	22	25	-	dB
Isolation 2	ISL2	f = 1.0 to 2.0 GHz	15	18	-	
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	14	17	-	
Isolation 4	ISL4	f = 2.5 to 3.0 GHz	10	13	-	
Input Return Loss	RLin	f = 0.5 to 3.0 GHz	15	20	-	dB
Output Return Loss	RLout	f = 0.5 to 3.0 GHz	15	20	-	dB
0.1 dB Loss Compression Input Power Note	Pin (0.1 dB)	f = 2.0/2.5 GHz	+18.0	+21.0	-	dBm
2nd Harmonics	2fo	f = 2.0/2.5 GHz, P _{in} = +10 dBm	65	75	-	dBc
3rd Harmonics	3fo	f = 2.0/2.5 GHz, P _{in} = +10 dBm	65	75	-	dBc
Supply Current	IDD	No signal	-	50	100	μА
Switch Control Current	Icont		-	4	20	μА
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	150	_	ns

Note P_{in (0.1 dB)} is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.

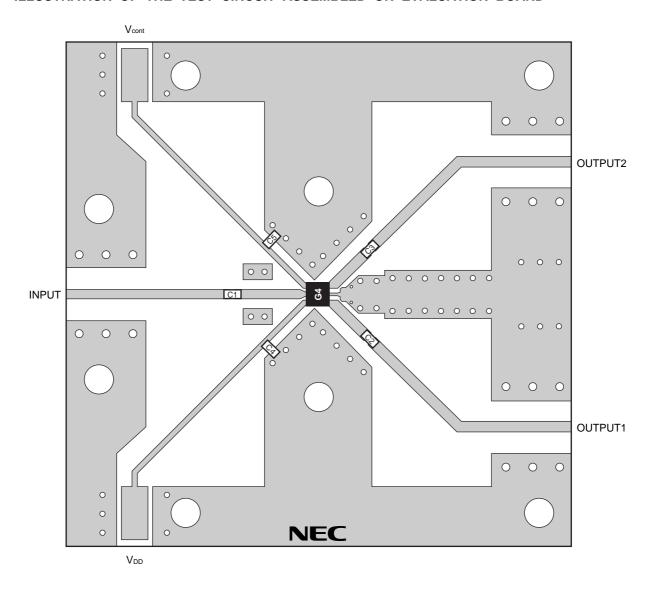
EVALUATION CIRCUIT



Remark Co: 56 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

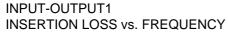
ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

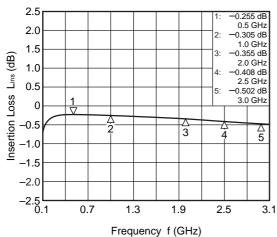


USING THE NEC EVALUATION BOARD

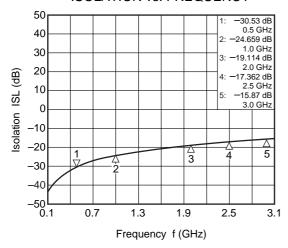
Symbol	Values		
C1, C2, C3	56 pF		
C4, C5	1 000 pF		

TYPICAL CHARACTERISTICS ($T_A = +25^{\circ}C$, $V_{DD} = 2.6 \text{ V}$, $V_{cont}(H) = 2.6 \text{ V}$, $V_{cont}(L) = 0 \text{ V}$, DC cut capacitors = 56 pF, using test fixture, unless otherwise specified)

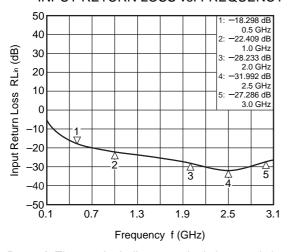




INPUT-OUTPUT1 ISOLATION vs. FREQUENCY

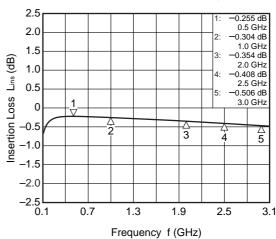


INPUT-OUTPUT1
INPUT RETURN LOSS vs. FREQUENCY

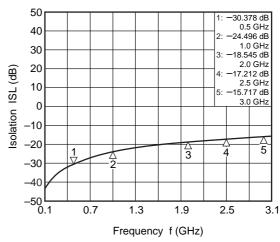


Remark The graphs indicate nominal characteristics.

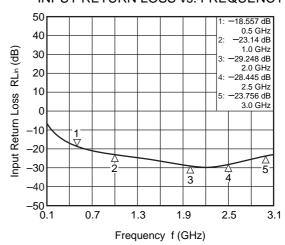
INPUT-OUTPUT2 INSERTION LOSS vs. FREQUENCY



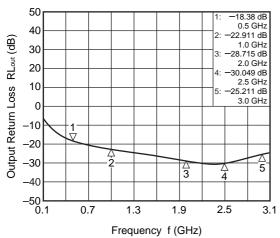
INPUT-OUTPUT2 ISOLATION vs. FREQUENCY



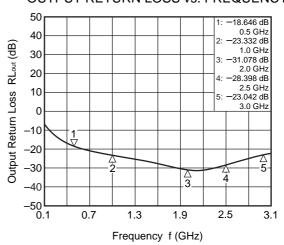
INPUT-OUTPUT2 INPUT RETURN LOSS vs. FREQUENCY



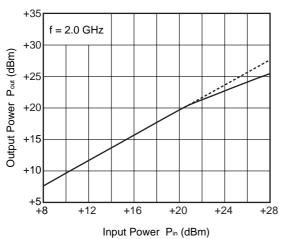
INPUT-OUTPUT1 OUTPUT RETURN LOSS vs. FREQUENCY



INPUT-OUTPUT2 OUTPUT RETURN LOSS vs. FREQUENCY



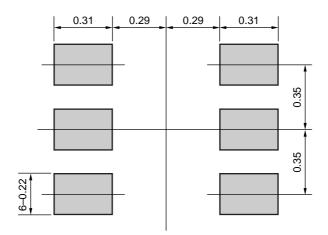
OUTPUT POWER vs. INPUT POWER



Remark The graphs indicate nominal characteristics.

MOUNTING PAD DIMENSIONS

6-PIN PLASTIC TSSON (UNIT: mm)

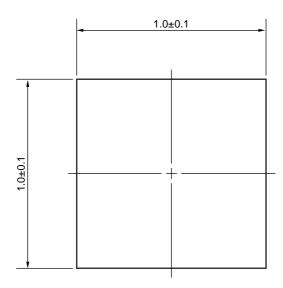


Remark The mounting pad layouts in this document are for reference only.

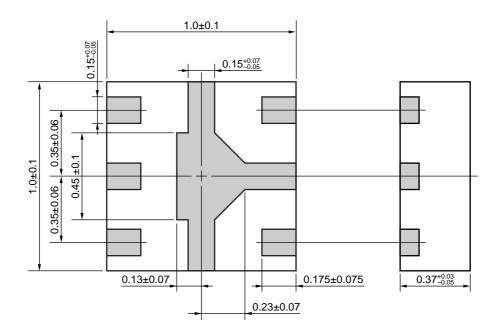
PACKAGE DIMENSIONS

6-PIN PLASTIC TSSON (UNIT: mm)

(Top View)



(Bottom View)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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M8E 02.11-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
 - 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

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This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A -AZ Not Detected (*)		
Mercury	< 1000 PPM	Not De	etected	
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM Not Detected		etected	

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